

60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET 18 January 2018 Product data sheet

1. General description

Complementary N/P-channel enhancement mode Field-Effect Transistor (FET) in a very small SOT363 (SC-88) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Trench MOSFET technology
- Very fast switching
- ElectroStatic Discharge (ESD) protection

3. Applications

- Relay driver
- High-speed line driver
- Level shifter
- Power supply converter

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit		
TR1 (N-chann	TR1 (N-channel)								
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	60	V		
I _D	drain current	V _{GS} = 10 V; T _{amb} = 25 °C	[1]	-	-	170	mA		
TR1 (N-channel), Static characteristics									
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 100 mA; T _j = 25 °C		-	3	4.5	Ω		
TR2 (P-chann	el)								
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	-50	V		
I _D	drain current	V _{GS} = -10 V; T _{amb} = 25 °C	[1]	-	-	-160	mA		
TR2 (P-chann	el), Static characteristic	S							
R _{DSon}	drain-source on-state resistance	V _{GS} = -10 V; I _D = -100 mA; T _j = 25 °C		-	4.5	7.5	Ω		

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².

nexperia

5. Pinning information

Table 2. I	Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	S1	source TR1	6 5 4	D1 D2				
2	G1	gate TR1						
3	D2	drain TR2	0					
4	S2	source TR2						
5	G2	gate TR2	TSSOP6 (SOT363)					
6	D1	drain TR1		S1 S2 017aaa262				

6. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
NX6020CAKS	TSSOP6	plastic surface-mounted package; 6 leads	SOT363			

7. Marking

Table 4. Marking codes	
Type number	Marking code[1]
NX6020CAKS	2A%

[1] % = placeholder for manufacturing site code

8. Limiting values

Table 5. Limiting values

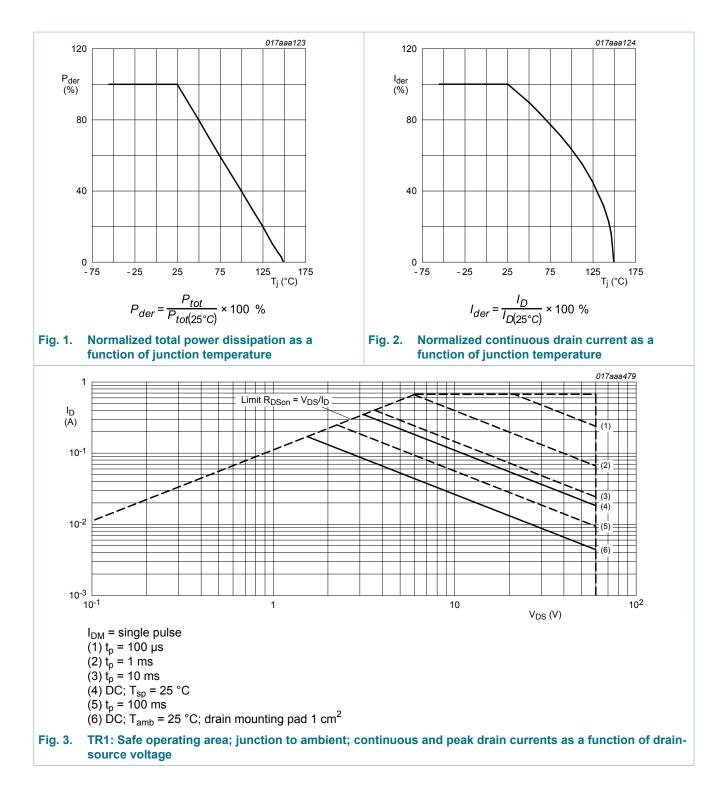
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
TR1 (N-char	inel)			·		
V _{DS}	drain-source voltage	T _j = 25 °C		-	60	V
V _{GS}	gate-source voltage			-20	20	V
I _D	drain current	V _{GS} = 10 V; T _{amb} = 25 °C	[1]	-	170	mA
		V _{GS} = 10 V; T _{amb} = 100 °C	[1]	-	100	mA
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	680	mA
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	220	mW
			[1]	-	255	mW
		T _{sp} = 25 °C		-	1.06	W
TR2 (P-chan	inel)		1			
V _{DS}	drain-source voltage	T _j = 25 °C		-	-50	V
V _{GS}	gate-source voltage			-20	20	V
I _D	drain current	V _{GS} = -10 V; T _{amb} = 25 °C	[1]	-	-160	mA
		V _{GS} = -10 V; T _{amb} = 100 °C	[1]	-	-100	mA
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-640	mA
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	280	mW
			[1]	-	320	mW
		T _{sp} = 25 °C		-	990	mW
Per device					I	
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	330	mW
Tj	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C
TR1 (N-char	nnel), Source-drain diode		1]
I _S	source current	T _{amb} = 25 °C	[1]	-	170	mA
TR2 (P-chan	inel), Source-drain diode		1			
ls	source current	T _{amb} = 25 °C	[1]	-	-160	mA

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².

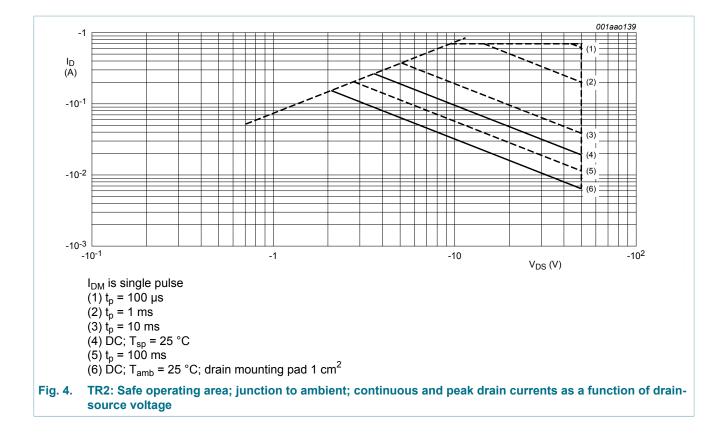
[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper; tin-plated and standard footprint.

60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET



NX6020CAKS

60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET

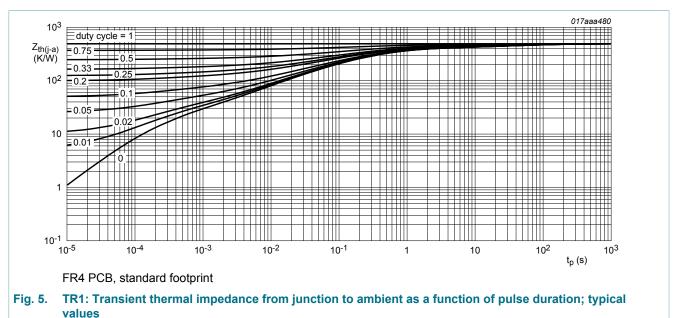


9. Thermal characteristics

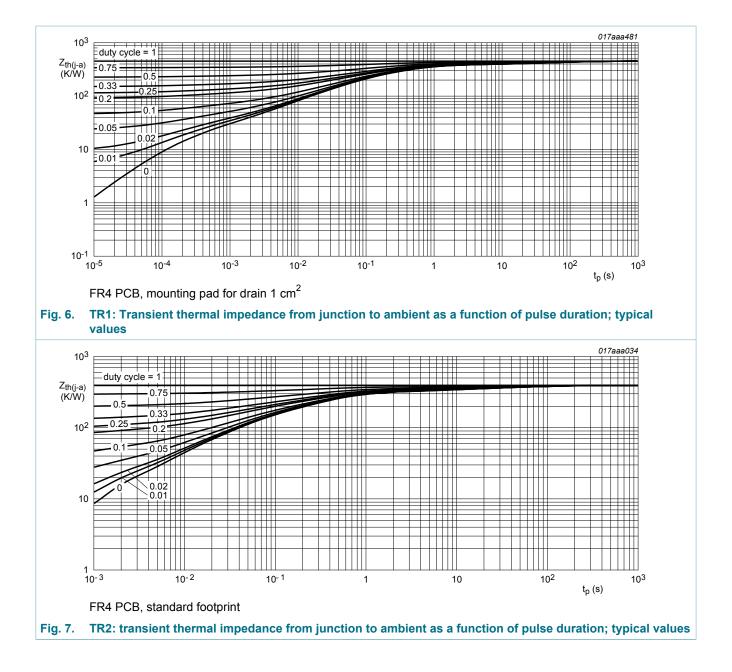
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
TR1 (N-chai	nnel)						
R _{th(j-a)}	thermal resistance	in free air	[1]	-	500	560	K/W
from junction to ambient		[2]	-	450	480	K/W	
R _{th(j-sp)}	thermal resistance from junction to solder point			-	-	115	K/W
TR2 (P-char	nnel)			1			
R _{th(j-a)}	thermal resistance	in free air	[1]	-	390	445	K/W
	from junction to ambient		[2]	-	340	390	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	-	130	K/W
Per device		'		1			
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	-	300	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper; tin-plated and standard footprint.

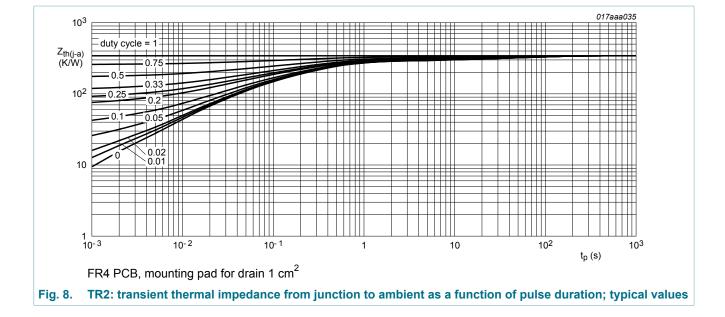
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².



60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET



60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET



10. Characteristics

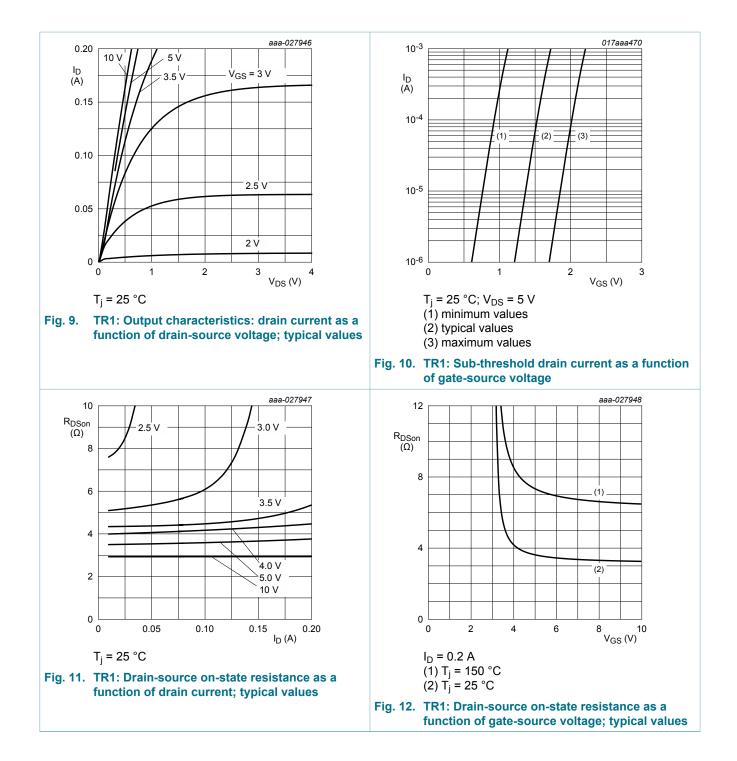
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1 (N-cha	nnel), Static characteristic	S				
V _{(BR)DSS}	drain-source breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _j = 25 °C	60	-	-	V
V _{GSth}	gate-source threshold voltage	$I_D = 250 \ \mu A; V_{DS} = V_{GS}; T_j = 25 \ ^{\circ}C$	1.1	1.6	2.1	V
I _{DSS}	drain leakage current	$V_{DS} = 60 \text{ V}; V_{GS} = 0 \text{ V}; \text{ T}_{j} = 25 \text{ °C}$	-	-	1	μA
		V _{DS} = 60 V; V _{GS} = 0 V; T _j = 150 °C	-	-	10	μA
I _{GSS}	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	-	2	μA
		V_{GS} = -20 V; V_{DS} = 0 V; T_j = 25 °C	-	-	2	μA
		V _{GS} = 10 V; V _{DS} = 0 V; T _j = 25 °C	-	-	0.5	μA
		V_{GS} = -10 V; V_{DS} = 0 V; T_j = 25 °C	-	-	0.5	μA
		V _{GS} = 5 V; V _{DS} = 0 V; T _j = 25 °C	-	-	100	nA
		V _{GS} = -5 V; V _{DS} = 0 V; T _j = 25 °C	-	-	100	nA
R _{DSon}	drain-source on-state	V _{GS} = 10 V; I _D = 100 mA; T _j = 25 °C	-	3	4.5	Ω
	resistance	V _{GS} = 10 V; I _D = 100 mA; T _j = 150 °C	-	6.2	9.2	Ω
		V _{GS} = 5 V; I _D = 100 mA; T _j = 25 °C	-	3.7	5.2	Ω
9 _{fs}	forward transconductance	V_{DS} = 10 V; I _D = 200 mA; T _j = 25 °C	-	230	-	mS
TR2 (P-chai	nnel), Static characteristic	S	1			
V _{(BR)DSS}	drain-source breakdown voltage	I_D = -10 µA; V_{GS} = 0 V; T_j = 25 °C	-50	-	-	V
V _{GSth}	gate-source threshold voltage	I_D = -250 µA; V_{DS} = V_{GS} ; T_j = 25 °C	-1.1	-1.6	-2.1	V
I _{DSS}	drain leakage current	V_{DS} = -50 V; V_{GS} = 0 V; T_j = 25 °C	-	-	-1	μA
		V _{DS} = -50 V; V _{GS} = 0 V; T _j = 150 °C	-	-	-2	μA
I _{GSS}	gate leakage current	V_{GS} = -20 V; V_{DS} = 0 V; T_j = 25 °C	-	-	-10	μA
		V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	-	-10	μA
R _{DSon}	drain-source on-state	V _{GS} = -10 V; I _D = -100 mA; T _j = 25 °C	-	4.5	7.5	Ω
	resistance	V _{GS} = -10 V; I _D = -100 mA; T _j = 150 °C	-	8	13.5	Ω
		V _{GS} = -5 V; I _D = -100 mA; T _j = 25 °C	-	5.7	8.5	Ω
9fs	forward transconductance	V_{DS} = -10 V; I _D = -100 mA; T _j = 25 °C	-	150	-	mS
TR1 (N-cha	nnel), Dynamic characteri	stics				
Q _{G(tot)}	total gate charge	V_{DS} = 30 V; I _D = 200 mA; V _{GS} = 4.5 V;	-	0.33	0.43	nC
Q _{GS}	gate-source charge	T _j = 25 °C	-	0.12	-	nC
Q _{GD}	gate-drain charge		-	0.09	-	nC

NX6020CAKS

60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET

$ \begin{array}{cccc} C_{iss} & \mbox{input capacitance} & V_{DS} = 10 \ \mbox{ispace}; f = 1 \ \mbox{MHz}; V_{GS} = 0 \ \mbox{V}; f = 1 \ \mbox{MHz}; V_{GS} = 0 \ \mbox{V}; f = 25 \ \ \mbox{C} & \mbox{C} & \mbox{S} & \m$		Unit
$\begin{array}{c c} C_{OSS} & Output capacitance & & & & & & & & & & & & & & & & & & &$	17	pF
$ \begin{array}{ c c c c } \hline capacitance & capacitance $	-	pF
$\begin{array}{c c} r_{r} & rise time \\ t_{r} & rise time \\ t_{d(off)} & turn-off delay time \\ t_{f} & fall time \\ \end{array} \qquad \begin{array}{c c} P_{G(ext)} = 6 \ \Omega; \ \overline{T}_{j} = 25 \ ^{\circ}C \\ \hline & - & 7 \\ \hline & - & 20 \\ \hline & - & 14 \\ \end{array} \\ \hline \textbf{TR2 (P-channel), Dynamic characteristics} \\ \hline Q_{G(tot)} & total gate charge \\ Q_{GS} & gate-source charge \\ \end{array} \qquad \begin{array}{c c} V_{DS} = -25 \ V; \ I_{D} = -200 \ \text{mA}; \ V_{GS} = -5 \ V; \\ \hline T_{j} = 25 \ ^{\circ}C \\ \hline & - & 0.12 \\ \end{array}$	-	pF
t_r Insertine $ 7$ $t_{d(off)}$ turn-off delay time-20 t_f fall time-14TR2 (P-channel), Dynamic characteristics $Q_{G(tot)}$ total gate charge $V_{DS} = -25 \text{ V}; I_D = -200 \text{ mA}; V_{GS} = -5 \text{ V};$ -0.26 Q_{GS} gate-source charge $V_{JS} = 25 \text{ °C}$ -0.12	12	ns
t_f fall time-14TR2 (P-channel), Dynamic characteristics $Q_{G(tot)}$ total gate charge $V_{DS} = -25 \text{ V}; I_D = -200 \text{ mA}; V_{GS} = -5 \text{ V};$ -0.26 Q_{GS} gate-source charge $V_{T_j} = 25 \text{ °C}$ -0.12	-	ns
TR2 (P-channel), Dynamic characteristics $Q_{G(tot)}$ total gate charge $V_{DS} = -25 \text{ V}; I_D = -200 \text{ mA}; V_{GS} = -5 \text{ V};$ -0.26 Q_{GS} gate-source charge $T_j = 25 \text{ °C}$ -0.12	40	ns
$Q_{G(tot)}$ total gate charge $V_{DS} = -25 \text{ V}; I_D = -200 \text{ mA}; V_{GS} = -5 \text{ V};$ -0.26 Q_{GS} gate-source charge $T_j = 25 \text{ °C}$ -0.12	-	ns
Q_{GS} gate-source charge $T_j = 25 \text{ °C}$ - 0.12		
GGS gale-source charge , - 0.12	0.35	nC
Q _{GD} gate-drain charge - 0.09	-	nC
	-	nC
C _{iss} input capacitance $V_{DS} = -25 V$; f = 1 MHz; $V_{GS} = 0 V$; - 24	36	pF
C_{oss} output capacitance $T_j = 25 \ ^{\circ}C$ - 4.5	-	pF
C _{rss} reverse transfer - 1.3	-	pF
t _{d(on)} turn-on delay time V_{DS} = -30 V; R _L = 250 Ω; V _{GS} = -10 V; - 13	26	ns
$R_{G(ext)} = 6 \Omega; T_j = 25 °C$ - 11	-	ns
t _{d(off)} turn-off delay time - 48	96	ns
t _f fall time - 25	-	ns
TR1 (N-channel), Source-drain diode characteristics		
V_{SD} source-drain voltage I_{S} = 115 mA; V_{GS} = 0 V; T_{j} = 25 °C 0.47 0.7	1.2	V
TR2 (P-channel), Source-drain diode characteristics		
V_{SD} source-drain voltage I_{S} = -115 mA; V_{GS} = 0 V; T_{j} = 25 °C -0.48 -0.85	-1.2	V

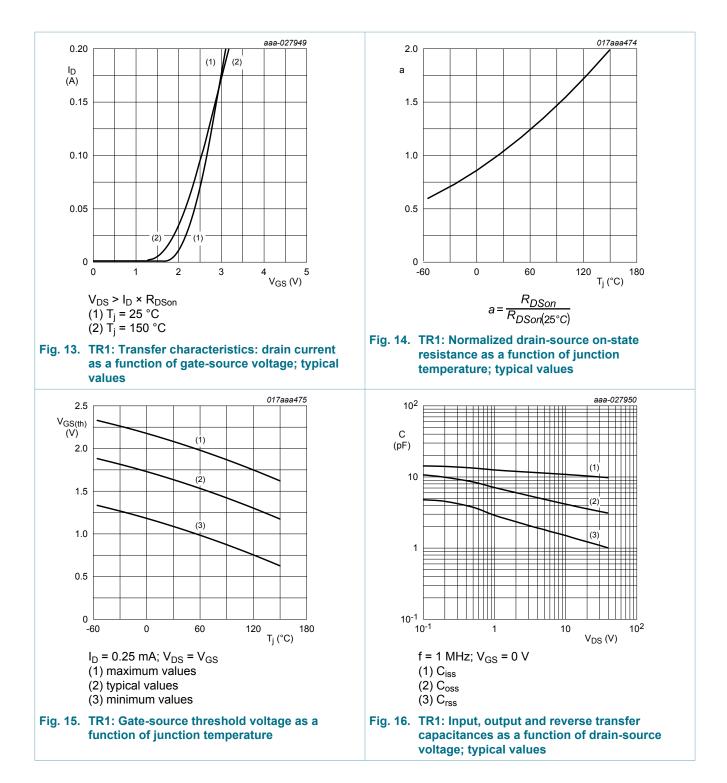
60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET



© Nexperia B.V. 2018. All rights reserved

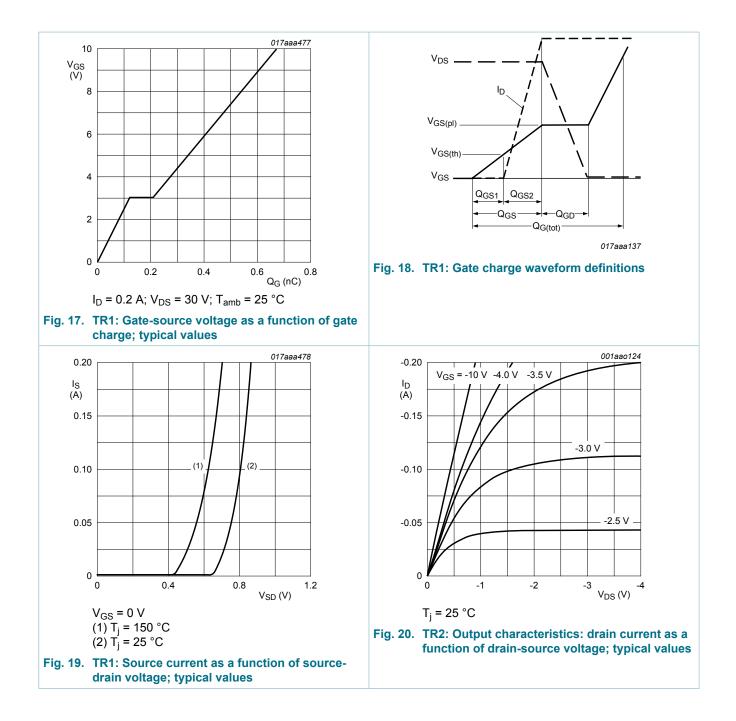
NX6020CAKS

60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET



NX6020CAKS

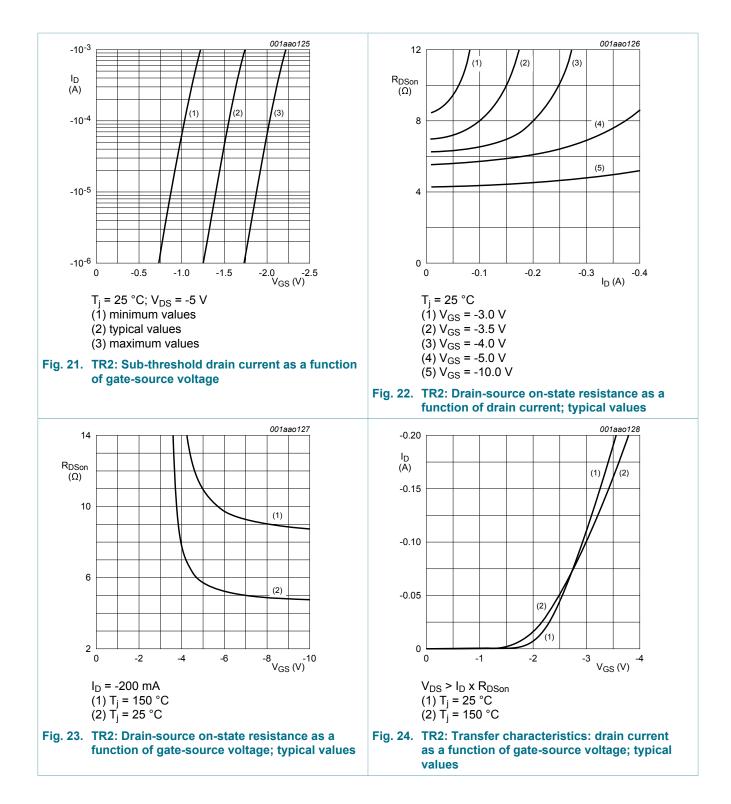
60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET



Product data sheet

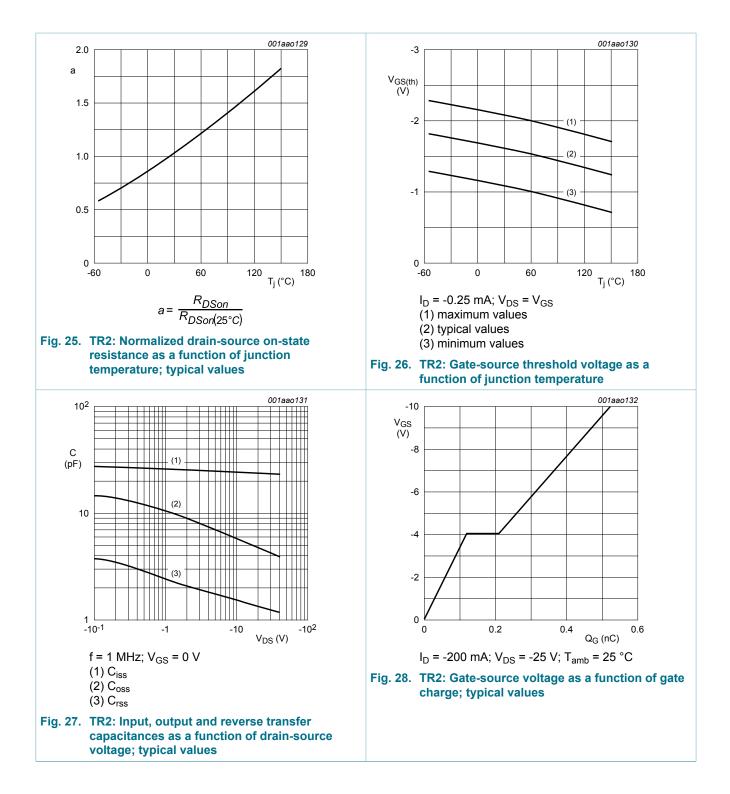
NX6020CAKS

60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET

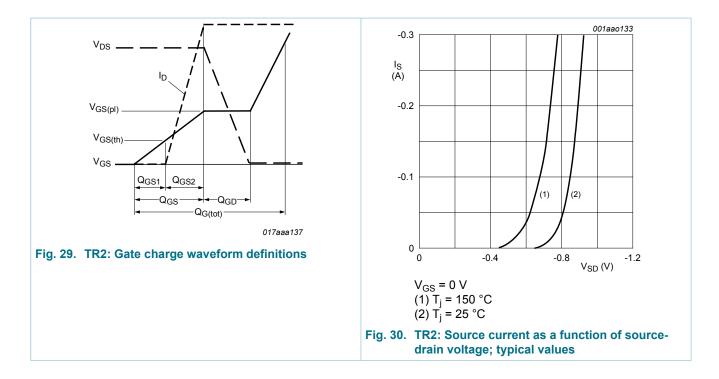


© Nexperia B.V. 2018. All rights reserved

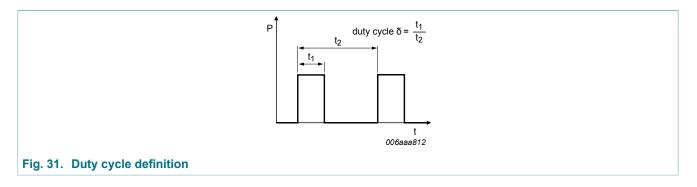
60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET



60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET

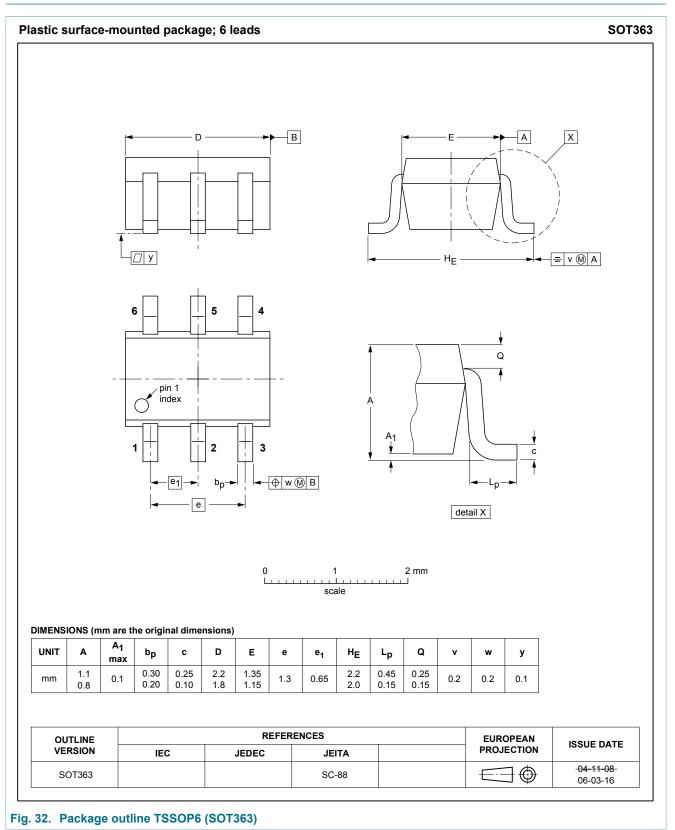


11. Test information



60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET

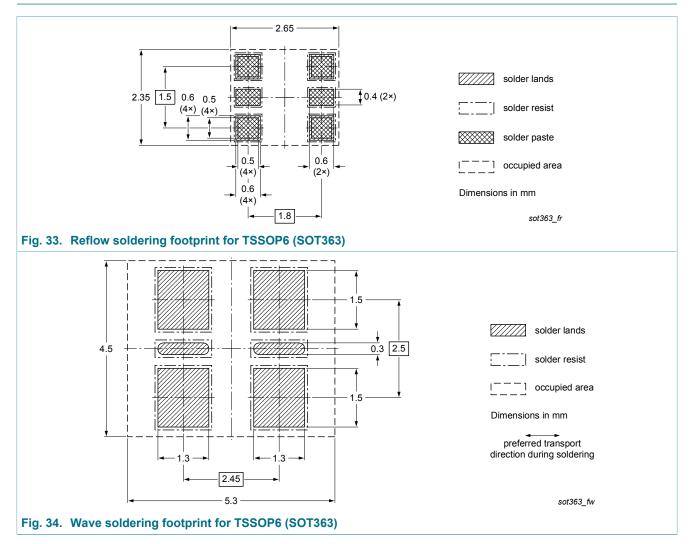
12. Package outline



NX6020CAKS

60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET

13. Soldering



Product data sheet

14. Revision history

Table 8. Revision history								
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes				
NX6020CAKS v.2	20180118	Product data sheet	-	NX6020CAKS v.1				
Modifications:	 Data sheet status cl Section: Limiting va 	hanged to Product. lues, ESD maximum ratin	ig removed.					
NX6020CAKS v.1	20171220	Preliminary data sheet	-	-				

60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <u>http://www.nexperia.com</u>.

Definitions

Preview — The document is a preview version only. The document is still subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Nexperia and its customer, unless Nexperia and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Nexperia product is deemed to offer functions and qualities beyond those described in the Product data sheet.

Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. Nexperia takes no responsibility for the content in this document if provided by an information source outside of Nexperia.

In no event shall Nexperia be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Nexperia' aggregate and cumulative liability towards customer

for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of Nexperia.

Right to make changes — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — Nexperia products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an Nexperia product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Nexperia and its suppliers accept no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Nexperia products, and Nexperia accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Nexperia product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Nexperia does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Nexperia products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Nexperia does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at <u>http://www.nexperia.com/profile/terms</u>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Nexperia hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Nexperia products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific Nexperia product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. Nexperia accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without Nexperia' warranty of the product for such automotive applications, use and specifications, and (b) whenever

60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET

customer uses the product for automotive applications beyond Nexperia' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies Nexperia for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond Nexperia' standard warranty and Nexperia' product specifications.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

60 V / 50 V, 170 mA / 160 mA N/P-channel Trench MOSFET

16. Contents

1. Ger	neral description	1
2. Fea	tures and benefits	1
3. Apj	plications	1
4. Qui	ck reference data	1
5. Pin	ning information	2
6. Ord	lering information	2
7. Ma	rking	2
8. Lim	niting values	3
9. The	ermal characteristics	6
10. Cł	naracteristics	9
11. Te	est information	16
12. Pa	ackage outline	17
13. So	oldering	18
14. Re	evision history	19
15. Le	gal information	20

© Nexperia B.V. 2018. All rights reserved

For more information, please visit: http://www.nexperia.com For sales office addresses, please send an email to: salesaddresses@nexperia.com Date of release: 18 January 2018

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Nexperia: NX6020CAKSX